

Green Products

Description

The SMP3022 includes back-to-back TVS diodes fabricated in a proprietary silicon avalanche technology to provide protection for electronic equipment that may experience destructive electrostatic discharges (ESD). These robust diodes can safely absorb repetitive ESD strikes up to the maximum level specified in the IEC61000-4-2 international standard (\pm 20kV contact discharge) without performance degradation. The back-to-back configuration provides symmetrical ESD protection for data lines when AC signals are present and the low loading capacitance makes it ideal for protecting high speed data lines such as HDMI, USB2.0, USB3.0 and eSATA.

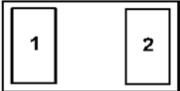
Features

- ESD protection in accordance with:
 IEC 61000-4-2 (ESD) ±30kV (air), ±20kV (contact)
 IEC 61000-4-5 (lightning) 3A (8/20µs)
 IEC 61000-4-4 (EFT) 40A (5/50ns)
- Low capacitance of 0.35pF @ V_R=0V (TYP)
- Low leakage current of 100nA at 5.3V(MAX)
- Extremely low dynamic resistance (0.7Ω TYP)

Applications

- USB 3.0/USB 2.0/MHL
- MIPI Camera and Display
- HDMI 2.0, DisplayPort 1.3, eSATA
- Set Top Boxes, Game Consoles
- Smart Phones
- External Storage
- Ultrabooks, Notebooks
- Tablets, eReaders
- High Speed Serial Interfaces

Pinout	Functional Block Diagram







Technical Data
Data Sheet N1741 Rev.Ordering Information:

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Device	Package	Packaging Options	P0/P1	Packaging Speciications	Min. Order Qty.
SMP3022-01ETG	SOD882	Tape & Reel - 8mm tape/7" reel	4mm/2mm	EIA RS-481	10000

Absolute Maximum Ratings:

Parameter	Symbol	Value	Unit
Peak Pulse Current (tp=8/20µs)	lpp	3.0	Α
Operating Temperature	Тор	-40 to + 125	°C
Peak Pulse Power (tP=8/20µs)	P _{PK}	20	W

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Thermal Information:

Parameter	Value	Unit
Storage Temperature Range	-55 to + 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 20-40s)	260	°C

Electrical Characteristics: (T_{OP}=25°C)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Units
Reverse Stand-Off Voltage	V_{RWM}	-	-	ı	5.3	٧
Reverse Breakdown Voltage	V_{BR}	I _{R=} 1mA	6.8	7.8	9.0	V
Reverse Leakage Current	I _{LEAK}	V _R =5.3V	-	<10	100	nA
Clamping Voltage ¹	V _C	I _{PP} = 1A, tp=8/20μs, Fwd	-	-	12.0	V
Dynamic Resistance ²	R_{DYN}	TLP, tp=100ns, I/O to GND	-	0.7	-	Ω
ESD With stand Voltage ¹	\/	IEC61000-4-2 (Contact)	±20	-	-	kV
	V _{ESD}	IEC61000-4-2 (Air)	±30	-	-	kV
Junction Capacitance ¹	C_D	Reverse Bias=0V, f=1 MHz	-	0.35	0.5	pF

Note: 1 Parameter is guaranteed by design and/or device characterization.

² Transmission Line Pulse (TLP) with 100ns width and 200ps rise time.

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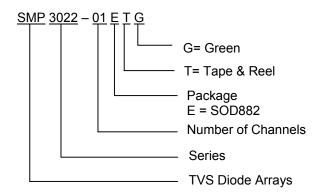


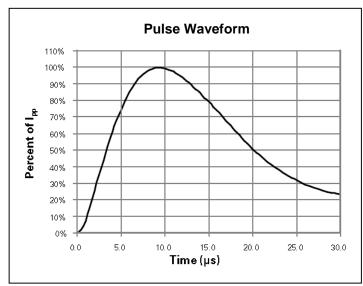
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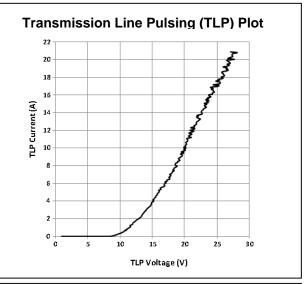
Marking Diagram:

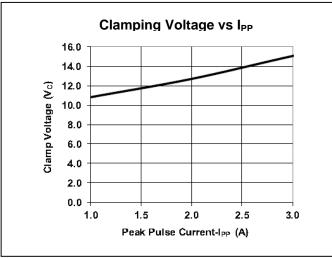


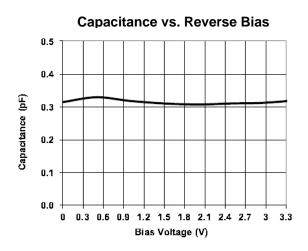
Part Name Information









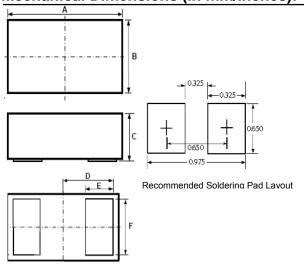


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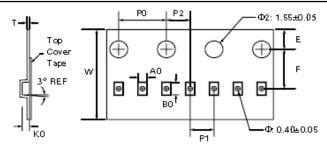
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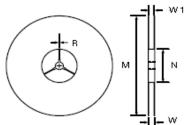
Mechanical Dimensions (In mm/Inches):

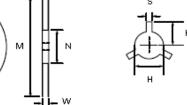


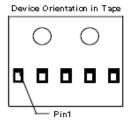
	Package		SOD882				
Symbol	JED	EC		MO-236			
Cyllibol	Millimeters			Inches			
	Min	Тур	Max	Min	Тур	Max	
Α	0.90	1.00	1.10	0.037	0.039	0.041	
В	0.50	0.60	0.70	0.022	0.024	0.026	
С	0.40	0.50	0.60	0.016	0.020	0.024	
D	0.45		0.018				
Е	0.20	0.25	0.35	0.008	0.010	0.012	
F	0.45	0.50	0.55	0.018	0.020	0.022	

Embossed Carrier Tape & Reel Specification — SOD882









Symb	Tape Dimensions			
Symb ol	Millimeters			
OI	Min	Max		
A0	0.65	0.75		
В0	1.10	1.20		
K0	0.50	0.60		
E	1.65	1.85		
F	3.45	3.55		
P0	3.90	4.10		
P1	1.90	2.10		
P2	1.95	2.05		
T	1.95	2.05		
W	7.90	8.10		

Cymahal	Reel Dimensions				
	(Size ∮178)				
Symbol	Millimeters				
	Min	Max			
M	177.0	179.0			
N	59.0	61.0			
W	11.0	12.0			
W1	8.5	9.5			
Н	12.5	13.5			
S	1.9	2.1			
K	10.8	11.2			
R	0.95	1.05			

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